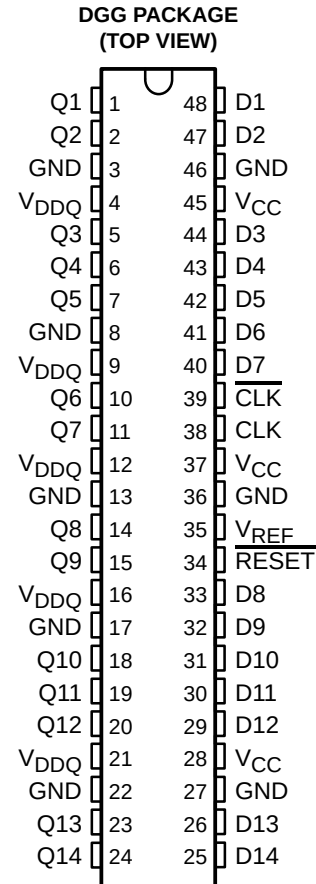


**SN74SSTVF16857**  
**14-BIT REGISTERED BUFFER**  
**WITH SSTL\_2 INPUTS AND OUTPUTS**  
 SCES411B – AUGUST 2002 – REVISED APRIL 2003

- Member of the Texas Instruments Widebus™ Family
- Operates at 2.3 V to 2.7 V for PC1600, PC2100, and PC2700; 2.5 V to 2.7 V for PC3200
- Pinout and Functionality Compatible With JEDEC Standard SSTV16857
- 600 ps Faster (Simultaneous Switching) Than JEDEC Standard SSTV16857 in PC2700 DIMM Applications
- Output Edge-Control Circuitry Minimizes Switching Noise in Unterminated DIMM Load
- Outputs Meet SSTL\_2 Class I Specifications
- Supports SSTL\_2 Data Inputs
- Differential Clock (CLK and  $\overline{\text{CLK}}$ ) Inputs
- Supports LVCMOS Switching Levels on the  $\overline{\text{RESET}}$  Input
- $\overline{\text{RESET}}$  Input Disables Differential Input Receivers, Resets All Registers, and Forces All Outputs Low
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



## description/ordering information

This 14-bit registered buffer is designed for 2.3-V to 2.7-V  $V_{CC}$  operation.

All inputs are SSTL\_2, except the LVCMOS reset ( $\overline{\text{RESET}}$ ) input. All outputs are edge-controlled circuits optimized for unterminated DIMM loads and meet SSTL\_2 Class I specifications.

The SN74SSTVF16857 operates from a differential clock (CLK and  $\overline{\text{CLK}}$ ). Data are registered at the crossing of CLK going high and  $\overline{\text{CLK}}$  going low.

## ORDERING INFORMATION

| $T_A$       | PACKAGE†    |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|-------------|-------------|---------------|-----------------------|------------------|
| 0°C to 70°C | TSSOP – DGG | Tape and reel | SN74SSTVF16857GR      | SSTVF16857       |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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# SN74SSTVF16857

## 14-BIT REGISTERED BUFFER

### WITH SSTL 2 INPUTS AND OUTPUTS

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#### description/ordering information (continued)

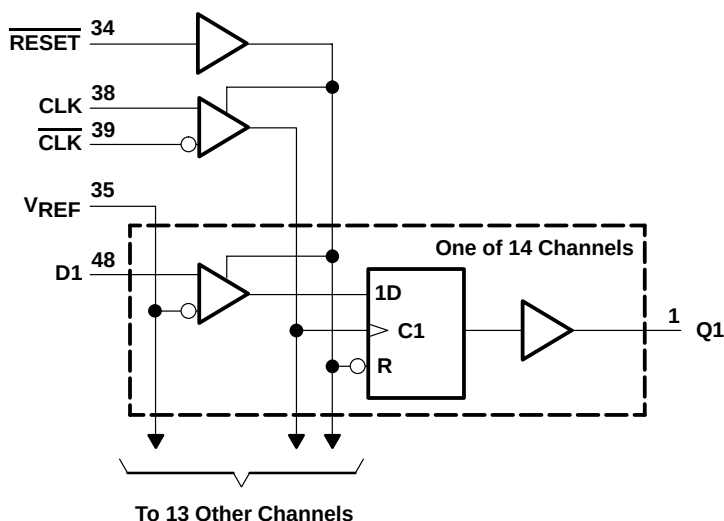
The device supports low-power standby operation. When  $\overline{\text{RESET}}$  is low, the differential input receivers are disabled, and undriven (floating) data, clock, and reference voltage ( $V_{\text{REF}}$ ) inputs are allowed. In addition, when  $\overline{\text{RESET}}$  is low, all registers are reset, and all outputs are forced low. The LVCMOS  $\overline{\text{RESET}}$  input always must be held at a valid logic high or low level.

To ensure defined outputs from the register before a stable clock has been supplied,  $\overline{\text{RESET}}$  must be held in the low state during power up.

FUNCTION TABLE

| INPUTS                    |                |                         |                | OUTPUT<br>Q |
|---------------------------|----------------|-------------------------|----------------|-------------|
| $\overline{\text{RESET}}$ | CLK            | $\overline{\text{CLK}}$ | D              |             |
| H                         | ↑              | ↓                       | H              | H           |
| H                         | ↑              | ↓                       | L              | L           |
| H                         | L or H         | L or H                  | X              | $Q_0$       |
| L                         | X, or floating | X, or floating          | X, or floating | L           |

#### logic diagram (positive logic)



**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

|                                                                 |                             |
|-----------------------------------------------------------------|-----------------------------|
| Supply voltage range, $V_{CC}$ or $V_{DDQ}$                     | –0.5 V to 3.6 V             |
| Input voltage range, $V_I$ (see Notes 1 and 2)                  | –0.5 V to $V_{CC} + 0.5$ V  |
| Output voltage range, $V_O$ (see Notes 1 and 2)                 | –0.5 V to $V_{DDQ} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                     | –50 mA                      |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{DDQ}$ ) | ±50 mA                      |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{DDQ}$ )     | ±50 mA                      |
| Continuous current through each $V_{CC}$ , $V_{DDQ}$ , or GND   | ±100 mA                     |
| Package thermal impedance, $\theta_{JA}$ (see Note 3)           | 70°C/W                      |
| Storage temperature range, $T_{stg}$                            | –65°C to 150°C              |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. This value is limited to 3.6 V maximum.  
3. The package thermal impedance is calculated in accordance with JESD 51-7.

**recommended operating conditions (see Note 4)**

|             |                                             |                        | MIN              | NOM  | MAX              | UNIT |
|-------------|---------------------------------------------|------------------------|------------------|------|------------------|------|
| $V_{CC}$    | Supply voltage                              |                        | $V_{DDQ}$        |      | 2.7              | V    |
| $V_{DDQ}$   | Output supply voltage                       | PC1600, PC2100, PC2700 | 2.3              |      | 2.7              | V    |
|             |                                             | PC3200                 | 2.5              |      | 2.7              |      |
| $V_{REF}$   | Reference voltage ( $V_{REF} = V_{DDQ}/2$ ) | PC1600, PC2100, PC2700 | 1.15             | 1.25 | 1.35             | V    |
|             |                                             | PC3200                 | 1.25             | 1.3  | 1.35             |      |
| $V_I$       | Input voltage                               |                        | 0                |      | $V_{CC}$         | V    |
| $V_{IH}$    | AC high-level input voltage                 | Data inputs            | $V_{REF}+310$ mV |      |                  | V    |
| $V_{IL}$    | AC low-level input voltage                  | Data inputs            |                  |      | $V_{REF}-310$ mV | V    |
| $V_{IH}$    | DC high-level input voltage                 | Data inputs            | $V_{REF}+150$ mV |      |                  | V    |
| $V_{IL}$    | DC low-level input voltage                  | Data inputs            |                  |      | $V_{REF}-150$ mV | V    |
| $V_{IH}$    | High-level input voltage                    | $\overline{RESET}$     | 1.7              |      |                  | V    |
| $V_{IL}$    | Low-level input voltage                     | $\overline{RESET}$     |                  |      | 0.7              | V    |
| $V_{ICR}$   | Common-mode input voltage range             | CLK, $\overline{CLK}$  | 0.97             |      | 1.53             | V    |
| $V_{I(PP)}$ | Peak-to-peak input voltage                  | CLK, $\overline{CLK}$  | 360              |      |                  | mV   |
| $I_{OH}$    | High-level output current                   |                        |                  |      | –16              | mA   |
| $I_{OL}$    | Low-level output current                    |                        |                  |      | 16               | mA   |
| $T_A$       | Operating free-air temperature              |                        | 0                |      | 70               | °C   |

NOTE 4: The  $\overline{RESET}$  input of the device must be held at valid logic voltage levels (not floating) to ensure proper device operation. The differential inputs must not be floating unless  $\overline{RESET}$  is low. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN74SSTVF16857

## 14-BIT REGISTERED BUFFER

### WITH SSTL 2 INPUTS AND OUTPUTS

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electrical characteristics for PC1600, PC2100, and PC2700 over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        |                                         | TEST CONDITIONS                                                                                                                                                                                     |  | V <sub>CC</sub> AND V <sub>DDQ</sub> | MIN                   | TYP† | MAX  | UNIT                 |     |    |
|------------------|-----------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--------------------------------------|-----------------------|------|------|----------------------|-----|----|
| V <sub>IK</sub>  |                                         | I <sub>I</sub> = −18 mA                                                                                                                                                                             |  | 2.3 V                                |                       |      | −1.2 | V                    |     |    |
| V <sub>OH</sub>  |                                         | I <sub>OH</sub> = −100 μA                                                                                                                                                                           |  | 2.3 V to 2.7 V                       | V <sub>DDQ</sub> −0.2 |      |      | V                    |     |    |
|                  |                                         | I <sub>OH</sub> = −8 mA                                                                                                                                                                             |  | 2.3 V                                | 1.95                  |      |      |                      |     |    |
| V <sub>OL</sub>  |                                         | I <sub>OL</sub> = 100 μA                                                                                                                                                                            |  | 2.3 V to 2.7 V                       |                       |      | 0.2  | V                    |     |    |
|                  |                                         | I <sub>OL</sub> = 8 mA                                                                                                                                                                              |  | 2.3 V                                |                       |      | 0.35 |                      |     |    |
| I <sub>I</sub>   | All inputs                              | V <sub>I</sub> = V <sub>CC</sub> or GND                                                                                                                                                             |  | 2.7 V                                |                       |      | ±5   | μA                   |     |    |
| I <sub>CC</sub>  | Static standby                          | RESET = GND                                                                                                                                                                                         |  | 2.7 V                                | I <sub>O</sub> = 0    |      |      | 10                   | μA  |    |
|                  | Static operating                        | RESET = V <sub>CC</sub> , V <sub>I</sub> = V <sub>IH</sub> (AC) or V <sub>IL</sub> (AC)                                                                                                             |  |                                      |                       | 8    |      | 25                   | mA  |    |
| I <sub>CCD</sub> | Dynamic operating – clock only          | RESET = V <sub>CC</sub> , V <sub>I</sub> = V <sub>IH</sub> (AC) or V <sub>IL</sub> (AC), CLK and CLK switching 50% duty cycle                                                                       |  | 2.5 V                                | I <sub>O</sub> = 0    | 28   |      | μA/MHz               |     |    |
|                  | Dynamic operating – per each data input | RESET = V <sub>CC</sub> , V <sub>I</sub> = V <sub>IH</sub> (AC) or V <sub>IL</sub> (AC), CLK and CLK switching 50% duty cycle, One data input switching at one-half clock frequency, 50% duty cycle |  |                                      |                       | 7    |      | μA/clock MHz/D input |     |    |
| C <sub>i</sub>   | Data inputs                             | V <sub>I</sub> = V <sub>REF</sub> ± 310 mV                                                                                                                                                          |  | 2.5 V                                |                       |      | 2.5  | 3                    | 3.5 | pF |
|                  | CLK, CLK                                | V <sub>ICR</sub> = 1.25 V, V <sub>I</sub> (PP) = 360mV                                                                                                                                              |  |                                      |                       |      | 2.5  | 3                    | 3.5 |    |
|                  | RESET                                   | V <sub>I</sub> = V <sub>CC</sub> or GND                                                                                                                                                             |  |                                      |                       |      | 2.3  | 3                    | 3.5 |    |

† All typical values are at V<sub>CC</sub> = 2.5 V, T<sub>A</sub> = 25°C.

electrical characteristics for PC3200 over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        |                                         | TEST CONDITIONS                                                                                                                                                                                     |  | V <sub>CC</sub> AND<br>V <sub>DDQ</sub> | MIN                   | TYP† | MAX  | UNIT                 |    |
|------------------|-----------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|-----------------------------------------|-----------------------|------|------|----------------------|----|
| V <sub>IK</sub>  |                                         | I <sub>I</sub> = −18 mA                                                                                                                                                                             |  | 2.5 V                                   |                       |      | −1.2 | V                    |    |
| V <sub>OH</sub>  |                                         | I <sub>OH</sub> = −100 μA                                                                                                                                                                           |  | 2.5 V to 2.7 V                          | V <sub>DDQ</sub> −0.2 |      |      | V                    |    |
|                  |                                         | I <sub>OH</sub> = −8 mA                                                                                                                                                                             |  | 2.5 V                                   | 1.95                  |      |      |                      |    |
| V <sub>OL</sub>  |                                         | I <sub>OL</sub> = 100 μA                                                                                                                                                                            |  | 2.5 V to 2.7 V                          |                       |      | 0.2  | V                    |    |
|                  |                                         | I <sub>OL</sub> = 8 mA                                                                                                                                                                              |  | 2.5 V                                   |                       |      | 0.35 |                      |    |
| I <sub>I</sub>   | All inputs                              | V <sub>I</sub> = V <sub>CC</sub> or GND                                                                                                                                                             |  | 2.7 V                                   |                       |      | ±5   | μA                   |    |
| I <sub>CC</sub>  | Static standby                          | RESET = GND                                                                                                                                                                                         |  | 2.7 V                                   | I <sub>O</sub> = 0    |      | 10   | μA                   |    |
|                  | Static operating                        | RESET = V <sub>CC</sub> , V <sub>I</sub> = V <sub>IH</sub> (AC) or V <sub>IL</sub> (AC)                                                                                                             |  |                                         |                       |      | 8    | 25                   | mA |
| I <sub>CCD</sub> | Dynamic operating – clock only          | RESET = V <sub>CC</sub> , V <sub>I</sub> = V <sub>IH</sub> (AC) or V <sub>IL</sub> (AC), CLK and CLK switching 50% duty cycle                                                                       |  | 2.6 V                                   | I <sub>O</sub> = 0    |      | 28   | μA/MHz               |    |
|                  | Dynamic operating – per each data input | RESET = V <sub>CC</sub> , V <sub>I</sub> = V <sub>IH</sub> (AC) or V <sub>IL</sub> (AC), CLK and CLK switching 50% duty cycle, One data input switching at one-half clock frequency, 50% duty cycle |  |                                         |                       |      | 7    | μA/clock MHz/D input |    |
| C <sub>i</sub>   | Data inputs                             | V <sub>I</sub> = V <sub>REF</sub> ± 310 mV                                                                                                                                                          |  | 2.6 V                                   |                       | 2.5  | 3    | 3.5                  | pF |
|                  | CLK, CLK                                | V <sub>ICR</sub> = 1.25 V, V <sub>I</sub> (PP) = 360mV                                                                                                                                              |  |                                         |                       | 2.5  | 3    | 3.5                  |    |
|                  | RESET                                   | V <sub>I</sub> = V <sub>CC</sub> or GND                                                                                                                                                             |  |                                         |                       | 2.3  | 3    | 3.5                  |    |

† All typical values are at V<sub>CC</sub> = 2.6 V, T<sub>A</sub> = 25°C.



**timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)**

|                    |                                                          |                                    |                                                                | $V_{CC} = 2.5\text{ V}$<br>$\pm 0.2\text{ V}^\dagger$ |     | $V_{CC} = 2.6\text{ V}$<br>$\pm 0.1\text{ V}^\dagger$ |     | UNIT |
|--------------------|----------------------------------------------------------|------------------------------------|----------------------------------------------------------------|-------------------------------------------------------|-----|-------------------------------------------------------|-----|------|
|                    |                                                          |                                    |                                                                | MIN                                                   | MAX | MIN                                                   | MAX |      |
| f <sub>clock</sub> | Clock frequency                                          |                                    |                                                                | 250                                                   |     | 250                                                   |     | MHz  |
| t <sub>w</sub>     | Pulse duration, CLK, $\overline{\text{CLK}}$ high or low |                                    |                                                                | 2                                                     |     | 2                                                     |     | ns   |
| t <sub>act</sub>   | Differential inputs active time (see Note 5)             |                                    |                                                                | 22                                                    |     | 22                                                    |     | ns   |
| t <sub>inact</sub> | Differential inputs inactive time (see Note 6)           |                                    |                                                                | 22                                                    |     | 22                                                    |     | ns   |
| t <sub>su</sub>    | Setup time                                               | Fast slew rate (see Notes 7 and 9) | Data before CLK $\uparrow$ , $\overline{\text{CLK}}\downarrow$ | 0.75                                                  |     | 0.75                                                  |     | ns   |
|                    |                                                          | Slow slew rate (see Notes 8 and 9) |                                                                | 0.9                                                   |     | 0.9                                                   |     |      |
| t <sub>h</sub>     | Hold time                                                | Fast slew rate (see Notes 7 and 9) | Data after CLK $\uparrow$ , $\overline{\text{CLK}}\downarrow$  | 0.75                                                  |     | 0.75                                                  |     | ns   |
|                    |                                                          | Slow slew rate (see Notes 8 and 9) |                                                                | 0.9                                                   |     | 0.9                                                   |     |      |

<sup>†</sup> For this test condition,  $V_{DDQ}$  always is equal to  $V_{CC}$ .

- NOTES: 5.  $V_{REF}$  must be held at a valid input level and data inputs must be held low for a minimum time of  $t_{\text{act}}$  max, after  $\overline{\text{RESET}}$  is taken high.  
6.  $V_{REF}$ , data, and clock inputs must be held at valid voltage levels (not floating) for a minimum time of  $t_{\text{inact}}$  max, after  $\overline{\text{RESET}}$  is taken low.  
7. For data signal input slew rate  $\geq 1\text{ V/ns}$ .  
8. For data signal input slew rate  $\geq 0.5\text{ V/ns}$  and  $< 1\text{ V/ns}$ .  
9. CLK,  $\overline{\text{CLK}}$  signals input slew rates are  $\geq 1\text{ V/ns}$ .

**switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)**

| PARAMETER                | FROM<br>(INPUT)                 | TO<br>(OUTPUT) | $V_{CC} = 2.5\text{ V}$<br>$\pm 0.2\text{ V}^\dagger$ |     | $V_{CC} = 2.6\text{ V}$<br>$\pm 0.1\text{ V}^\dagger$ |     | UNIT |
|--------------------------|---------------------------------|----------------|-------------------------------------------------------|-----|-------------------------------------------------------|-----|------|
|                          |                                 |                | MIN                                                   | MAX | MIN                                                   | MAX |      |
| $f_{\text{max}}$         |                                 |                | 250                                                   |     | 250                                                   |     | MHz  |
| $t_{\text{pd}}^\ddagger$ | CLK and $\overline{\text{CLK}}$ | Q              | 1.1                                                   | 2.6 | 1.1                                                   | 2.6 | ns   |
| $t_{\text{PHL}}$         | $\overline{\text{RESET}}$       | Q              | 5                                                     |     | 5                                                     |     | ns   |

<sup>†</sup> For this test condition,  $V_{DDQ}$  always is equal to  $V_{CC}$ .

<sup>‡</sup> Single bit switching

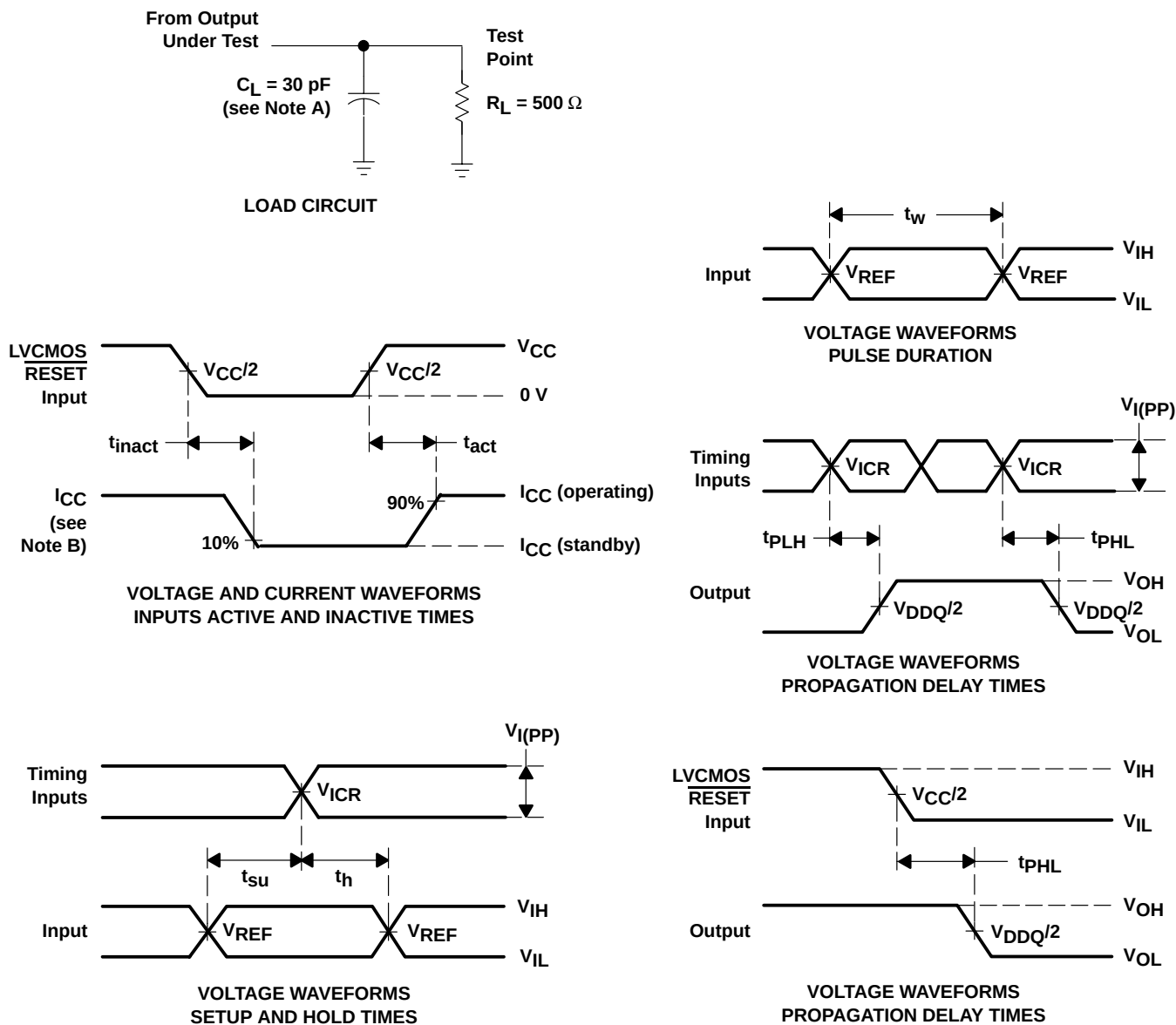
# SN74SSTVF16857

## 14-BIT REGISTERED BUFFER

### WITH SSTL 2 INPUTS AND OUTPUTS

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#### PARAMETER MEASUREMENT INFORMATION



- NOTES:
- $C_L$  includes probe and jig capacitance.
  - $I_{CC}$  tested with clock and data inputs held at  $V_{CC}$  or GND, and  $I_O = 0 \text{ mA}$ .
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ , input slew rate =  $1 \text{ V/ns} \pm 20\%$  (unless otherwise noted).
  - The outputs are measured one at a time with one transition per measurement.
  - $V_{REF} = V_{DDQ}/2$
  - $V_{IH} = V_{REF} + 310 \text{ mV}$  (ac voltage levels) for differential inputs.  $V_{IH} = V_{CC}$  for LVC MOS input.
  - $V_{IL} = V_{REF} - 310 \text{ mV}$  (ac voltage levels) for differential inputs.  $V_{IL} = \text{GND}$  for LVC MOS input.
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable Device   | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|--------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74SSTVF16857GR   | ACTIVE                | TSSOP        | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| SN74SSTVF16857GRG4 | ACTIVE                | TSSOP        | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| SN74SSTVF16857VR   | ACTIVE                | TVSOP        | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74SSTVF16857VRG4 | ACTIVE                | TVSOP        | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

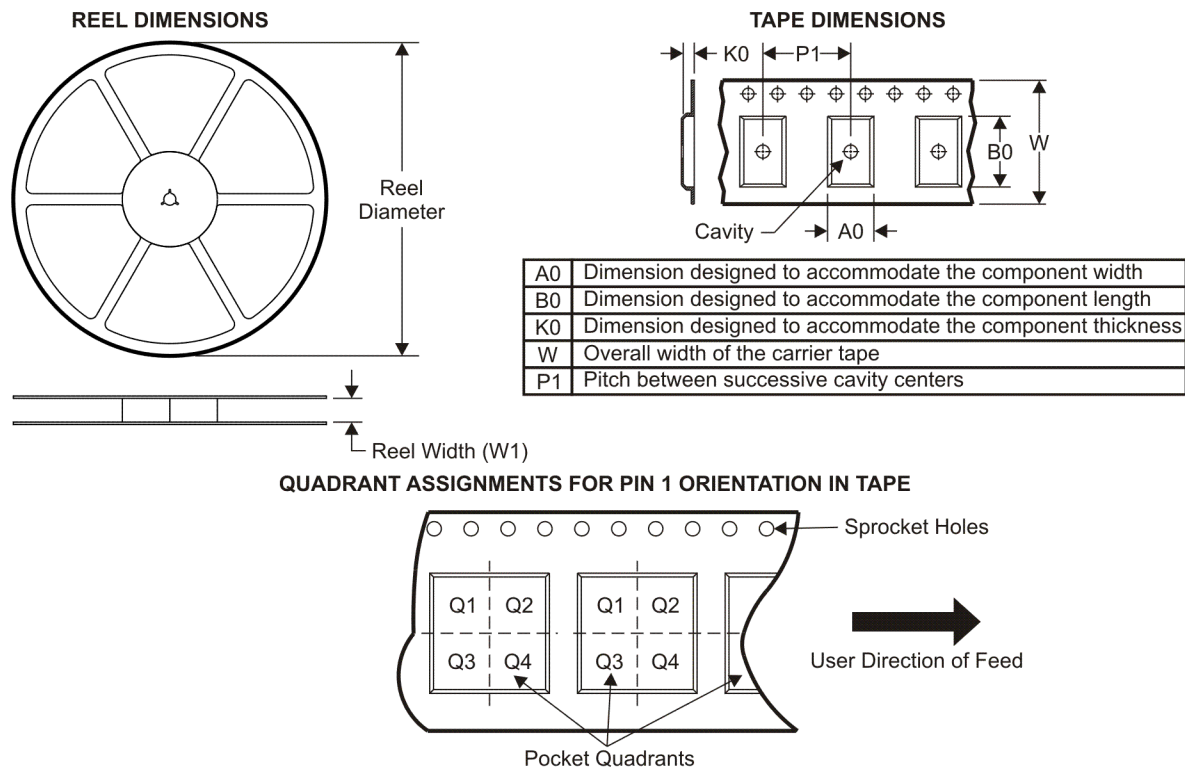
**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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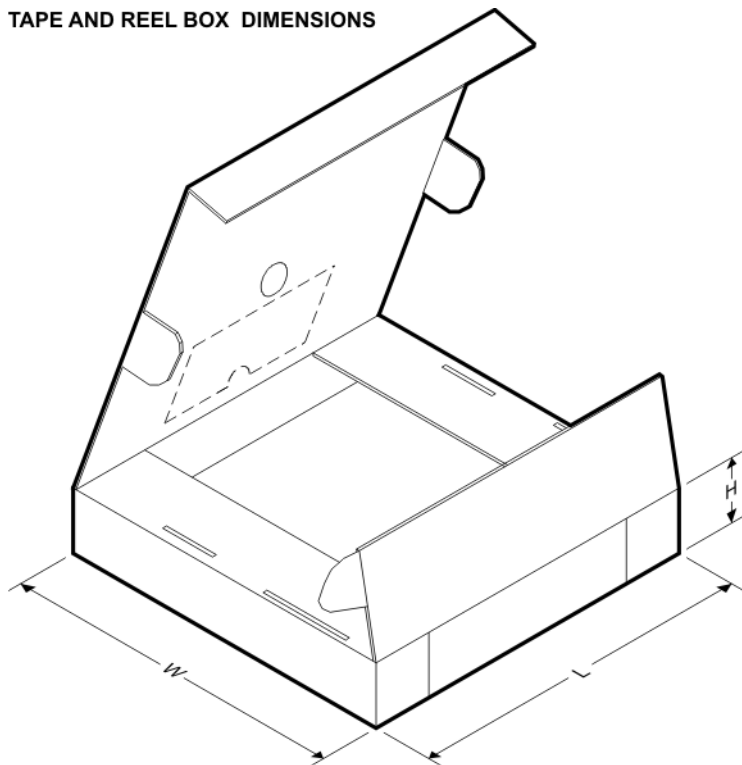
**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74SSTVF16857GR | TSSOP        | DGG             | 48   | 2000 | 330.0              | 24.4               | 8.6     | 15.8    | 1.8     | 12.0    | 24.0   | Q1            |
| SN74SSTVF16857VR | TVSOP        | DGV             | 48   | 2000 | 330.0              | 16.4               | 7.1     | 10.2    | 1.6     | 12.0    | 16.0   | Q1            |



## TAPE AND REEL BOX DIMENSIONS



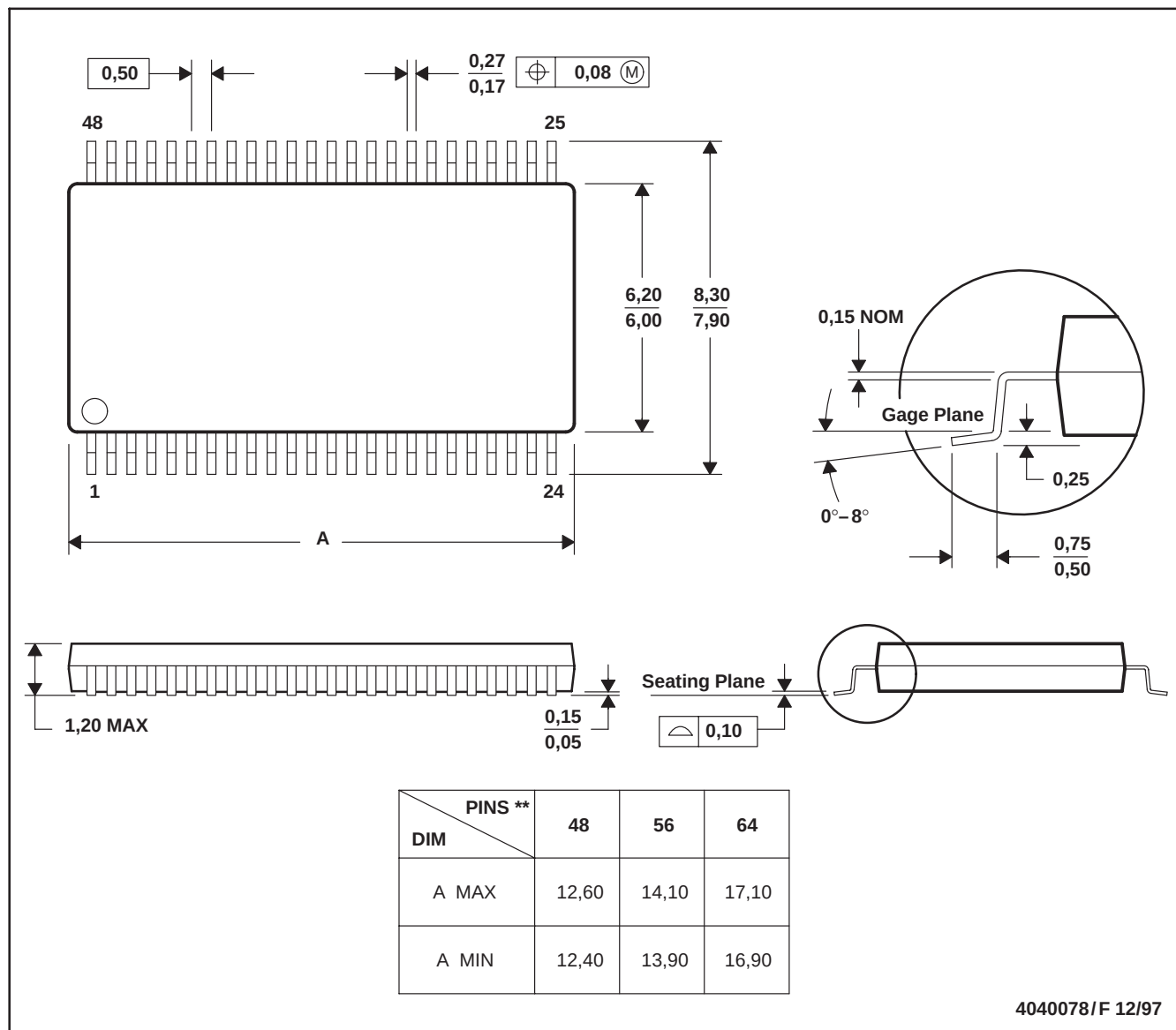
\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74SSTVF16857GR | TSSOP        | DGG             | 48   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74SSTVF16857VR | TVSOP        | DGV             | 48   | 2000 | 346.0       | 346.0      | 33.0        |

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

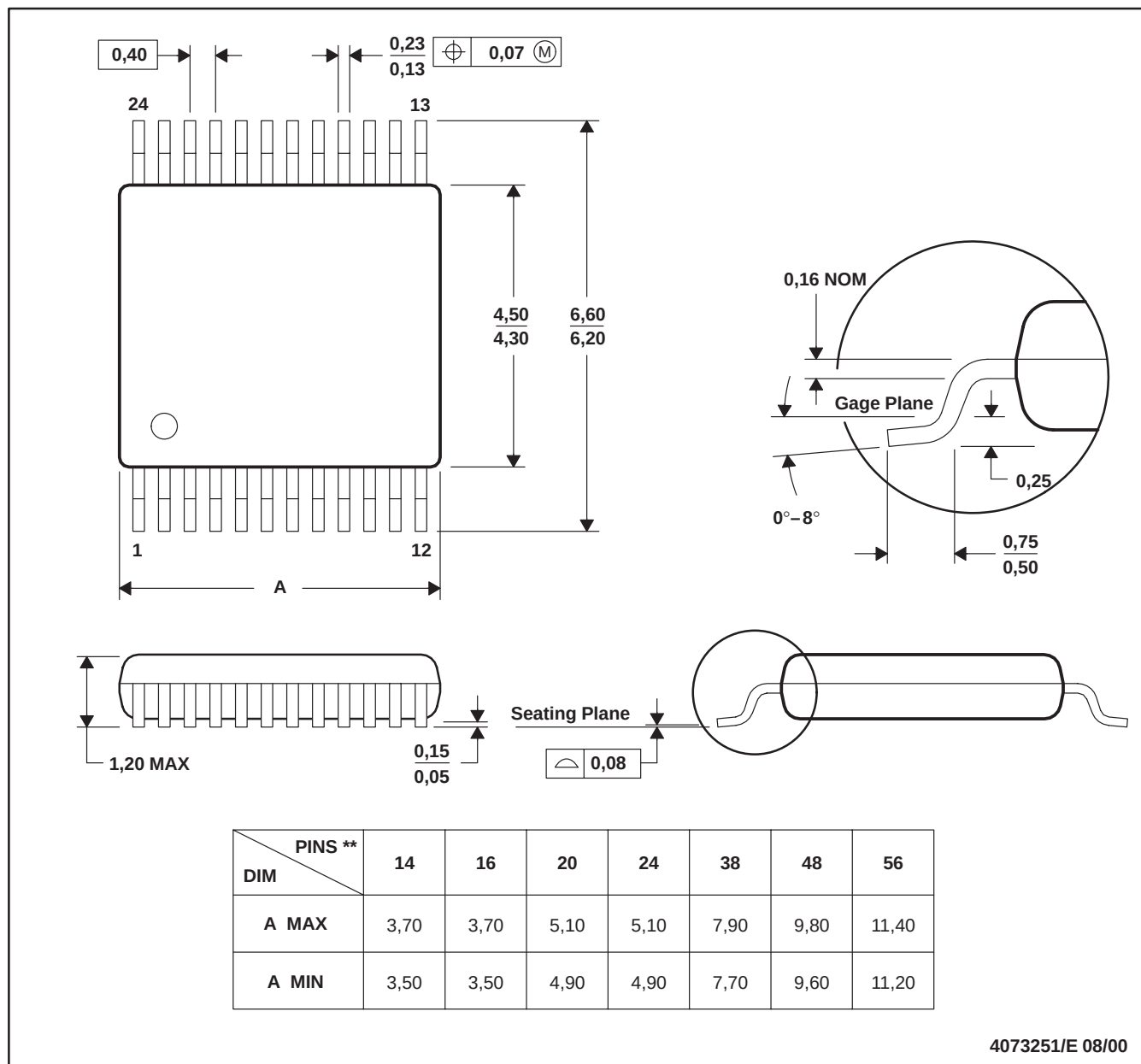


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

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|                    |                                                                          |
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